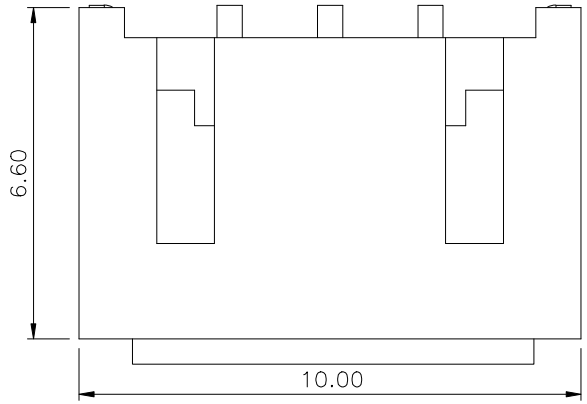
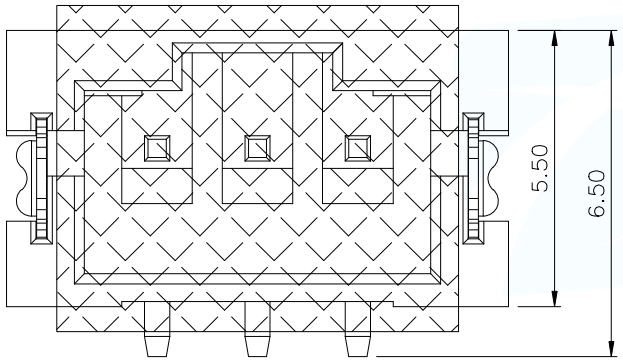
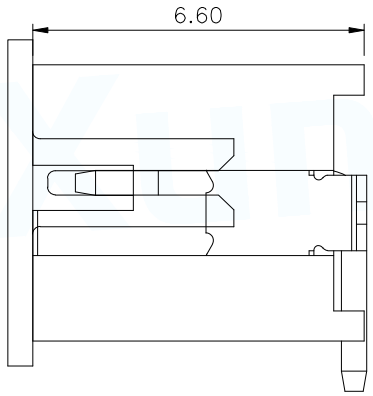
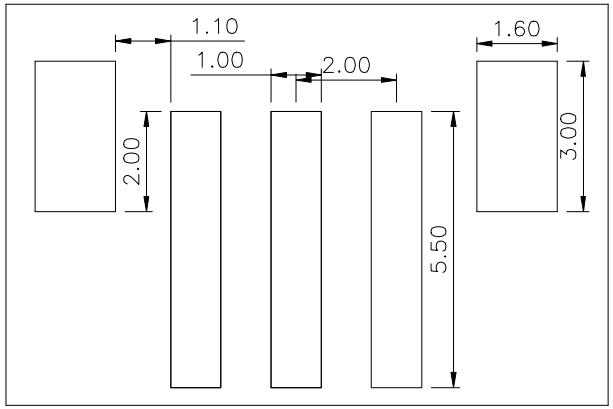
ROHS Compliant

MAPX	MODIFICATION	DATE	DRAW	APPROVE









RECOMMENDED P.C.B HOLE LAYOUT

NOTES:

1.MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V_0

CONTACT: COPPER ALLOYS.

COVER: COPPER ALLOYS OR STEEL.

2.PLATING:

UNDERPLATE: NICKEL.

SPECIFICATIONS:

Voltage Rating:125V AC DC

Current Rating:1A AC,DC

Withstanding voltage:500V AC 1/Minute

Insulation Resistance:100MΩ Min

Contact Resistance:20mΩ Max

Temperatuer Range:−25℃ ~+ 85℃

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co,Ltd			
UNLESS OTHERWISE SPECIFED TOLERANCES			TITLE: WAFER 2.00 立贴3P		
			PAR	WAFER−200L−3P	
DECIMALS:	ANGLES:		DWN		
X.X:±0.35	X.X°:±3°		CHKD		
X.XX:±0.25	X.XX:±2°		APVD		
X.XXX:±0.15		CUSTOMER COPY	SCALE1:1	UNIT:MM	
			SIZE:A4	SHEET:1F1	REV:A

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XUNPU:

WAFER-PH2.0-8PLB FPC-0.5FX-14PWCR-H20 HDMI-212L WAFER-MX1.25B-8PWB WAFER-PH2.0-6PWB WAFER-VH3.96-4PLB FPC-0.5AS-5PWCR-H20 FPC-0.5FX-20PWBH15 WAFER-WBM4.2-16PJK-GB FPC-0.5FX-16PWCR-H20 FPC-0.5HF-10PWBR-H20 FPC-1.0AX-4PWCR-H25 SMA-KWE-323C-H13X23-LW FPC-0.5FX-4PWCR-H20 WAFER-GH1.25-6PLB WAFER-XH2.54-4PWZ-H62 FPC-0.5AX-24PWCR-H20 FPC-1.0AX-14PWCR-H25 PHB2.0-02-20PZZ TYPEC-304YDSW-ACP16 WAFER-PH2.0-11PZZ WAFER-PH2.0-3PWB FPC-0.5AL-6PB FPC-0.5AX-30PWCR-H20 FPC-0.5FX-4PWBH15 FPC-1.0HF-4PWAR-H20 MU-103-ARW64 RJ45-005-014-11 DC-031A-A100 WAFER-PH2.0-2PJK